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N-Channel PowerTrench[®] MOSFET 30 V, 3.8 m Ω

Features

- Max $r_{DS(on)}$ = 3.8 m Ω at V_{GS} = 10 V, I_D = 21 A
- Max $r_{DS(on)} = 5.0 \text{ m}\Omega$ at $V_{GS} = 4.5 \text{ V}$, $I_D = 17 \text{ A}$
- Advanced Package and Silicon design for low r_{DS(on)} and high efficiency
- Next generation enhanced body diode technology, engineered for soft recovery. Provides Schottky-like performance with minimum EMI in sync buck converter applications
- MSL1 robust package design
- 100% UIL tested
- RoHS Compliant

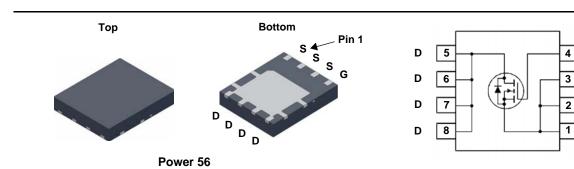


General Description

This N-Channel MOSFET has been designed specifically to improve the overall efficiency and to minimize switch node ringing of DC/DC converters using either synchronous or conventional switching PWM controllers. It has been optimized for low gate charge, low $r_{DS(on)}$, fast switching speed and body diode reverse recovery performance.

Applications

- IMVP Vcore Switching for Notebook
- VRM Vcore Switching for Desktop and Server
- OringFET / Load Switch
- DC-DC Conversion



MOSFET Maximum Ratings T_A = 25 °C unless otherwise noted

Symbol	Parameter			Ratings	Units	
V _{DS}	Drain to Source Voltage			30	V	
V _{GS}	Gate to Source Voltage		(Note 4)	±20	V	
ID	Drain Current -Continuous (Package limited)	T _C = 25 °C		42		
	-Continuous (Silicon limited)	T _C = 25 °C		105		
	-Continuous	T _A = 25 °C	(Note 1a)	21	Α	
	-Pulsed			150		
E _{AS}	Single Pulse Avalanche Energy		(Note 3)	144	mJ	
P _D	Power Dissipation	T _C = 25 °C		62	W	
	Power Dissipation	T _A = 25 °C	(Note 1a)	2.5		
T _J , T _{STG}	Operating and Storage Junction Temperature Range			-55 to +150	°C	

Thermal Characteristics

R_{\thetaJC}	Thermal Resistance, Junction to Case	2.0	°C/W
$R_{ ext{ heta}JA}$	Thermal Resistance, Junction to Ambient (Note	1a) 50	0/10

Package Marking and Ordering Information

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
FDMS7670	FDMS7670	Power 56	13 "	12 mm	3000 units

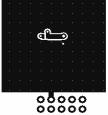
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Symbol	Parameter	Test Conditions	Min	Тур	Max	Units
Off Chara	cteristics					
BV _{DSS}	Drain to Source Breakdown Voltage	I _D = 250 μA, V _{GS} = 0 V				V
$\frac{\Delta BV_{DSS}}{\Delta T_{I}}$	Breakdown Voltage Temperature Coefficient	$I_D = 250 \ \mu\text{A}, \ V_{GS} = 0 \ V \ 30$ $I_D = 250 \ \mu\text{A}, \ referenced to 25 \ ^{\circ}\text{C}$		15		mV/°C
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} = 24 V, V _{GS} = 0 V			1	μA
I _{GSS}	Gate to Source Leakage Current, Forward	$V_{GS} = 20 \text{ V}, \text{ V}_{DS} = 0 \text{ V}$			100	nA
	cteristics					
V _{GS(th)}	Gate to Source Threshold Voltage	$V_{GS} = V_{DS}, I_{D} = 250 \ \mu A$	1.25	1.9	3.0	V
$\frac{\Delta V_{GS(th)}}{\Delta T_{.1}}$	Gate to Source Threshold Voltage Temperature Coefficient	$I_D = 250 \ \mu\text{A}$, referenced to 25 °C	1.20	-7	0.0	mV/°C
j	Static Drain to Source On Resistance	V _{GS} = 10 V, I _D = 21 A		2.9	3.8	
r _{DS(on)}		$V_{GS} = 4.5 \text{ V}, I_D = 17 \text{ A}$		4.1	5.0	mΩ
		$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 21 \text{ A}, \text{ T}_{J} = 125 \text{ °C}$				1
9fs	Forward Transconductance	V _{DS} = 5 V, I _D = 21 A		136		S
Dvnamic	Characteristics					
C _{iss}	Input Capacitance			3085	4105	pF
C _{oss}	Output Capacitance	$V_{DS} = 15 \text{ V}, \text{ V}_{GS} = 0 \text{ V},$		990	1315	pF
C _{rss}	Reverse Transfer Capacitance	_f = 1 MHz		75	115	pF
R _q	Gate Resistance			1.2	2.5	Ω
Switching	J Characteristics			15	26	ns
t _r	Rise Time	V _{DD} = 15 V, I _D = 21 A,		6	12	ns
t _{d(off)}	Turn-Off Delay Time	$V_{GS} = 10 \text{ V}, \text{ R}_{GEN} = 6 \Omega$		31	50	ns
t _f	Fall Time	-		5	10	ns
Q _g	Total Gate Charge	V _{GS} = 0 V to 10 V		40	56	nC
Q _g	Total Gate Charge	$V_{GS} = 0 \text{ V to } 4.5 \text{ V}$ $V_{DD} = 15 \text{ V},$ $I_D = 21 \text{ A}$		17	24	nC
Q _{gs}	Gate to Source Charge			9.8		nC
Q _{gd}	Gate to Drain "Miller" Charge	-		4.4		nC
*	urce Diode Characteristics	1		I		
	$V_{CS} = 0 V_{LS} = 2.1 A$			0.7	0.95	V
V _{SD}	Source to Drain Diode Forward Voltage	$V_{GS} = 0 V, I_S = 21 A$ (Note 2)		0.8	1.1	v
t _{rr}	Reverse Recovery Time			38	61	ns
Q _{rr}	Reverse Recovery Charge			19	34	nC
t _a	Reverse Recovery Fall Time	I _F = 21 A, di/dt = 100 A/μs		14		ns
t _b	Reverse Recovery Rise Time			24		ns
S	Softness (t _b /t _a)			1.7		
t _{rr}	Reverse Recovery Time	I _F = 21 A, di/dt = 300 A/μs		32	51	ns
Q _{rr}	Reverse Recovery Charge			34	54	nC
Notes : 1. R _{θJA} is determ the user's boa	ined with the device mounted on a 1in ² pad 2 oz copper pad rd design.	on a 1.5 x 1.5 in. board of FR-4 material. $R_{\theta JC}$ is	guaranteed	by design wh	ile R _{0CA} is de	etermined I



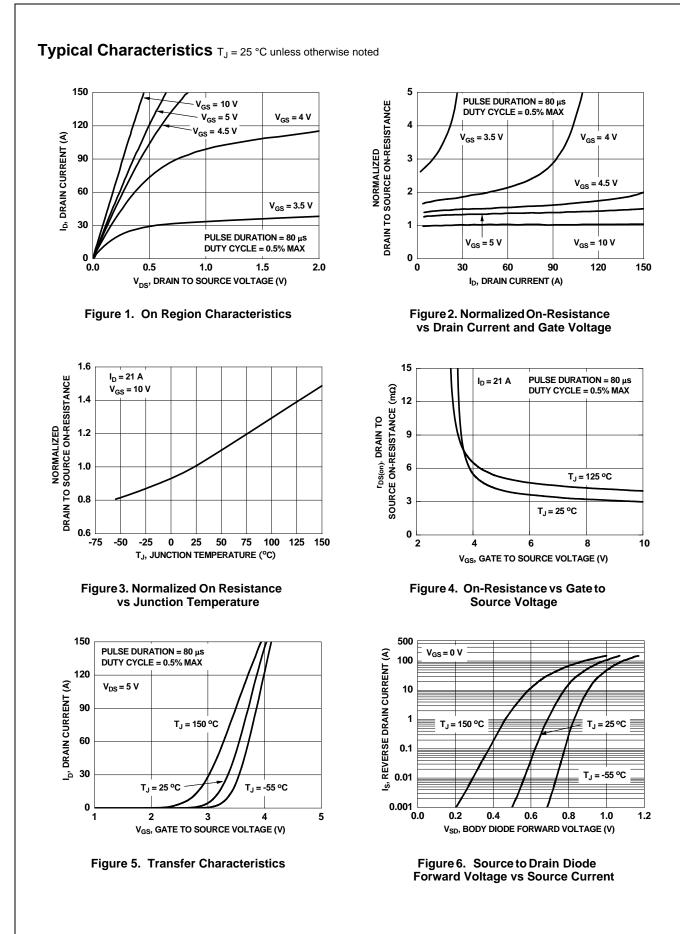
2. Pulse Test: Pulse Width < 300 $\mu s,$ Duty cycle < 2.0%.

3. E_{AS} of 144 mJ is based on starting T_J = 25 °C, L = 1 mH, I_{AS} = 17 A, V_{DD} = 27 V, V_{GS} = 10 V. 100% test at L = 0.3 mH, I_{AS} = 22 A.

4. As an N-ch device, the negative Vgs rating is for low duty cycle pulse occurrence only. No continuous rating is implied. ©2012 Fairchild Semiconductor Corporation 2 FDMS7670 Rev. D3

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FDMS7670 N-Channel PowerTrench[®] MOSFET



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- C_{iss}

Coss

Crss

10

100

125

SINGLE PULSE

R_{0JA} = 125 °C/W

100

= 25 °C

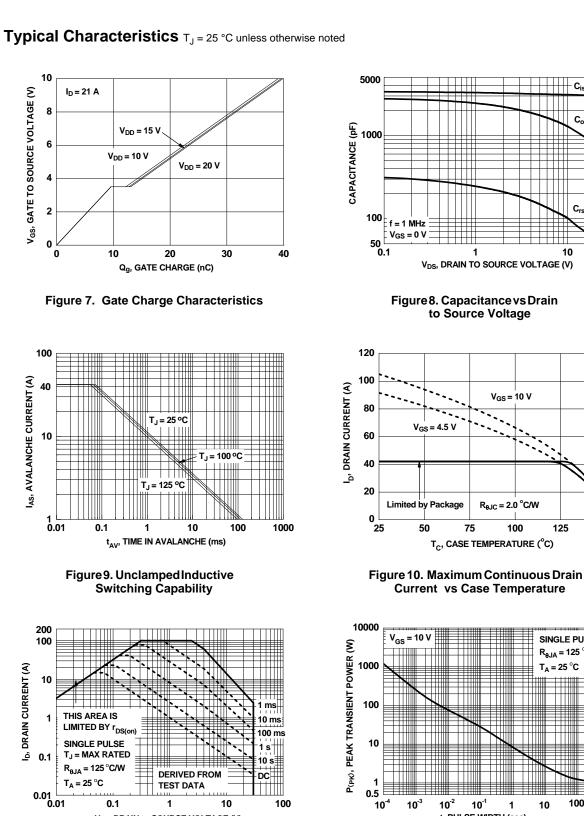
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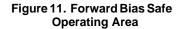
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1

150

30





1

V_{DS}, DRAIN to SOURCE VOLTAGE (V)

10

100

4

0.1

0.5

10⁻⁴

10

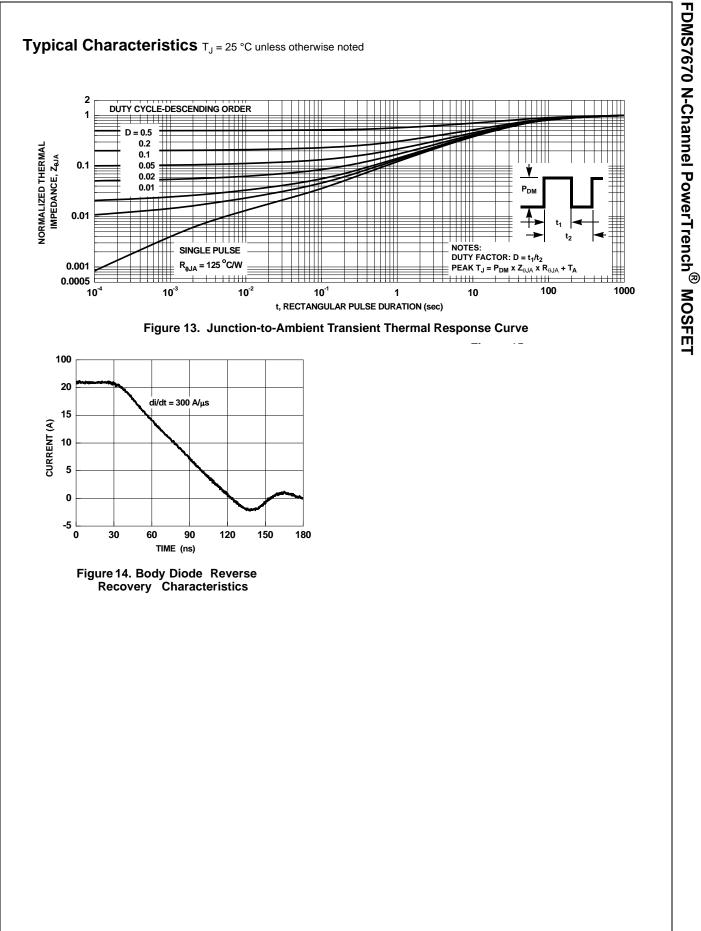
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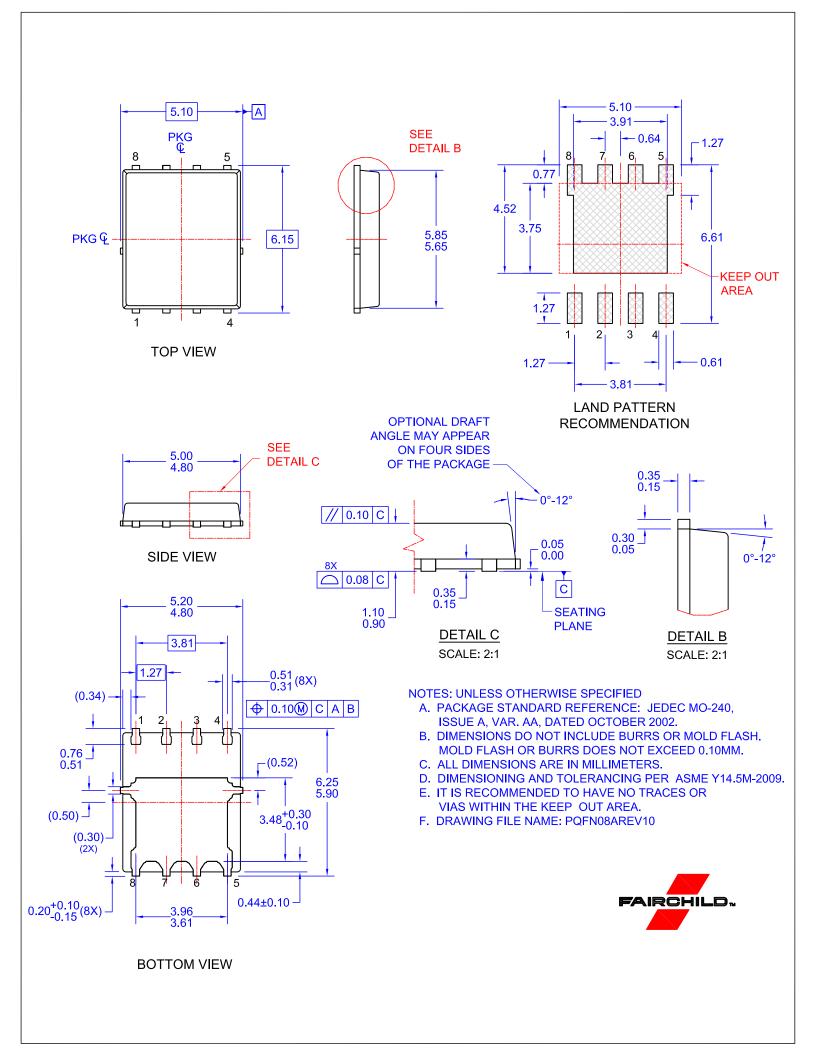
Figure 12. Single Pulse Maximum Power Dissipation

t, PULSE WIDTH (sec)

10⁻²

1000





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